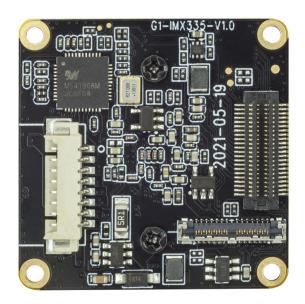
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YDS-CMFL108W-IMX335 V1.0 5.14MP Sony IMX335 Fixed Focus Camera Module



Front View



Back View

Overview

The YDS-CML108W-IMX335 V1.0 distortion-free lens module uses the Sony IMX335 high-quality CMOS image sensor, which has a diagonal of 6.52mm (1/2.8 type) CMOS image sensor, a pixel of 2.0um, a color square pixel display, and an effective pixel of 5.14 megapixels.

When used with the master board, it can support shooting 5MP pixel highdefinition photos and up to 2.7K@30FPS video. The board frame size is 32x32mm, and the size from the top of the module lens to the PCB board is 32x32x20mm.

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YDS-CMFL108W-IMX335 V1.0 5.14MP Sony IMX335 Fixed Focus Camera Module

Specifications

Model No.	YDS-CMFL108W-IMX335 V1.0		
Image Sensor	IMX335		
Image Sensor Type	CMOS		
Effective Pixels	5.14 Megapixels		
Sensor Size	1/2.8"		
Pixel Size	2.0 um x 2.0 um		
Video Frame Rate	4K@30FPS/60FPS (Differential) 2.7K@30FPS 1080P@30FPS/60FPS 720P@60FPS/120FPS		
Photo Resolution (with Master Board)	20MP (5200x3900) (Differential) 13MP (4160x3120) (Differential) 12MP (4000x3000) (Differential) 10MP (3648x2736) (Differential) 8MP (3264x2448) (Differential) 5MP (2592x1944) Default 3MP (2048x1536) 2MP (1920x1080)		
Operating Temperature	-10°C to +60°C		
Storage Temperature	-10°C to +60°C		
Humidity	20% to 80%		
PCB Dimensions	32 x 32 mm		
Module Size	32 x 32 x 20 mm		
PCB Screw Hole Spacing	28 x 28 mm		
PCB Screw Hole Diameter	2 mm		

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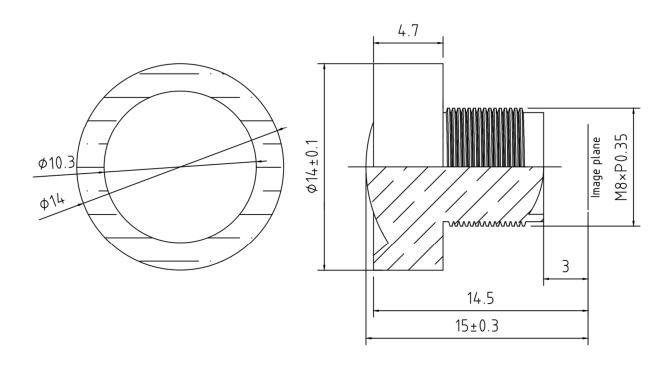
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YDS-CMFL108W-IMX335 V1.0 5.14MP Sony IMX335 Fixed Focus Camera Module

Lens Specifications

Lens Model No.	HX108W	
EFL (Focal Length)	2 mm	
TTL (Total Length)	15 mm	
F. No.	2.0	
Lens Barrel Thread	M12 x P0.5	
Lens Construction	6E	
Diagonal View Angle (DFOV)	122° (DFOV)	
Horizonal View Angle (HFOV)	107° (HFOV)	
Vertical View Angle (VFOV)	89° (VFOV)	
Chief-Ray Angle	17°	
Distortion	2.60%	
Relative Illumination	>41%	
Lens Operating Temperature	-10°C to +60°C	
Lens Storage Temperature	-20°C to +80°C	

Lens Drawing



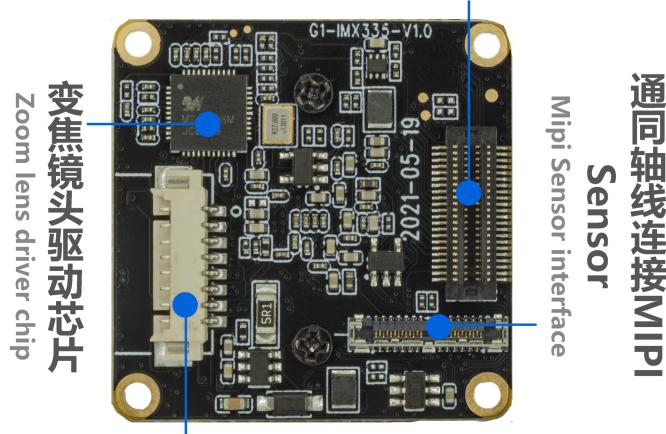
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YDS-CMFL108W-IMX335 V1.0 5.14MP Sony IMX335 Fixed Focus Camera Module

通过板对板连接器支持自动AF变焦镜头 Sensor、IR-CUT、LED等

Connect AF Zoom Lens, Sensor, IR-CUT, Led

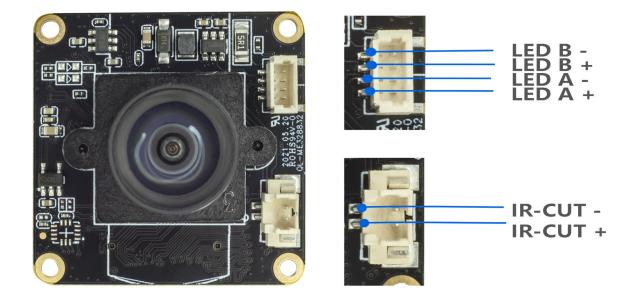




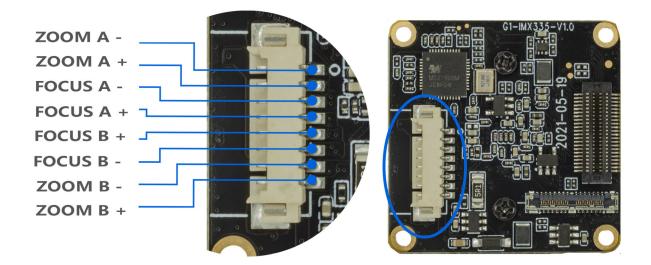
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YDS-CMFL108W-IMX335 V1.0 5.14MP Sony IMX335 Fixed Focus Camera Module



The two groups of fill light interfaces support the expansion of infrared lights and white light boards to provide fill light for the device. Note: The IR-Cut filter switch interface is used by lenses with filters, but this camera module does not support this function.

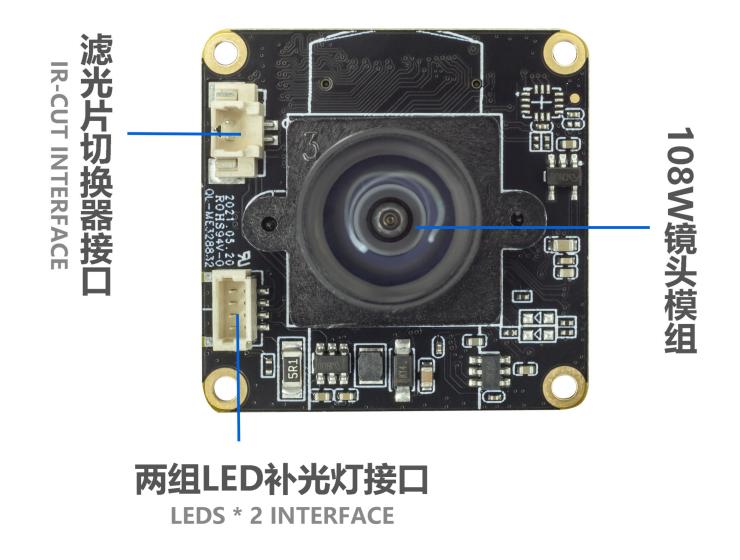


The auto focus interface leads to the connection automatically focusing motor to achieve the zoom function, but this camera module does not support zoom function.

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Note: You can choose between TBT board-to-board socket or connecting to the master board via coaxial cable. Users can use them flexibly according to the construction scenarios.

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YDS-CMFL108W-IMX335 V1.0 5.14MP Sony IMX335 Fixed Focus Camera Module



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SONY

[Product Information]

Ver.1.0

IMX335LLN

Diagonal 6.52 mm (Type 1 / 2.8) CMOS Solid-state Image Sensor with Square Pixel for Monochrome Cameras

Description

The IMX335LLN is a diagonal 6.52 mm (Type 1 / 2.8) CMOS active pixel type solid-state image sensor with a square pixel array and 5.14 M effective pixels. This chip operates with analog 2.9 V, digital 1.2 V, and interface 1.8 V triple power supply, and has low power consumption. High sensitivity, low dark current and no smear are achieved. This chip features an electronic shutter with variable charge-integration time. (Applications: Surveillance cameras, FA cameras, Industrial cameras)

Features

- CMOS active pixel type dots
- Built-in timing adjustment circuit, H/V driver and serial communication circuit
- ◆ Input frequency: 6 to 27 MHz / 37.125 MHz / 74.25 MHz
- ♦ Number of recommended recording pixels: 2592 (H) × 1944 (V) approx. 5.04 M pixels
- Readout mode
 - All-pixel scan mode
- Window cropping mode
- Vertical / Horizontal direction-normal / inverted readout mode
- Readout rate

Maximum frame rate in All-pixel scan mode 2592(H) x 1944(V) A/D 10-bit : 60 frame/s

High dynamic range (HDR) function

Multiple exposure HDR

Digital overlap HDR

- Variable-speed shutter function (resolution 1H units)
- 10-bit / 12-bit A/D converter
- CDS / PGA function
 0 dB to 30 dB : Analog Gain 30 dB (step pitch 0.3 dB)
 30.3 dB to 72 dB : Analog Gain 30 dB + Digital Gain 0.3 to 42 dB (step pitch 0.3 dB)
- Supports I/O CSI-2 serial data output (2 Lane / 4 Lane, RAW10 / RAW12 output)
- ◆ Recommended exit pupil distance: -100 mm to -∞

STARVIS

* STARVIS is a trademark of Sony Corporation. The STARVIS is back-illuminated pixel technology used in CMOS image sensors for surveillance camera applications. It features a sensitivity of 2000 mV or more per 1 µm² (color product, when imaging with a 706 cd/m² light source, F5.6 in 1 s accumulation equivalent), and realizes high picture quality in the visible-light and near infrared light regions.

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Device Structure

- CMOS image sensor
- ♦ Image size
- Total number of pixels
- Number of effective pixels
- Number of active pixels
- Number of recommended recording pixels
- Unit cell size
- Optical black
- ♦ Dummy
- Package

Type 1/2.8 2704 (H) × 2104 (V) approx. 5.69 M pixels 2616 (H) × 1964 (V) approx. 5.14 M pixels 2616 (H) × 1960 (V) approx. 5.13 M pixels 2592 (H) × 1944 (V) approx. 5.04 M pixels 2.0 μ m (H) × 2.0 μ m (V) Horizontal (H) direction: Front 0 pixel, rear 0 pixel Vertical (V) direction: Front 13 pixels, rear 0 pixel Horizontal (H) direction: Front 0 pixel, rear 0 pixel Vertical (V) direction: Front 0 pixel, rear 0 pixel 88 pin BGA

Image Sensor Characteristics

(Tj = 60 °C)

Item		Value	Remarks
Sensitivity (F8)	Тур.	1961 Digit	1/30 s accumulation 12 bit converted value
Saturation signal	Min.	3895 Digit	12 bit converted value

Basic Drive Mode

Drive mode	Recommended number of recording pixels	Maximum frame rate [frame/s]	Output interface	ADC [bit]
All pixel	2592 (H) × 1944 (V) approx. 5.04 M pixels	60	CSI-2	10

SONY

[Product Information]

Ver.1.1

IMX335LQN

Diagonal 6.52 mm (Type 1/2.8) CMOS Solid-state Image Sensor with Square Pixel for Color Cameras

Description

The IMX335LQN is a diagonal 6.52 mm (Type 1/2.8) CMOS active pixel type solid-state image sensor with a square pixel array and 5.14 M effective pixels. This chip operates with analog 2.9 V, digital 1.2 V, and interface 1.8 V triple power supply, and has low power consumption. High sensitivity, low dark current and no smear are achieved through the adoption of R, G and B primary color mosaic filters. This chip features an electronic shutter with variable charge-integration time.

(Applications: Surveillance cameras, FA cameras, Industrial cameras)

Features

- CMOS active pixel type dots
- Built-in timing adjustment circuit, H/V driver and serial communication circuit
- ◆ Input frequency: 6 to 27 MHz / 37.125 MHz / 74.25 MHz
- ♦ Number of recommended recording pixels: 2592 (H) × 1944 (V) approx. 5.04 M pixels
- Readout mode
- All-pixel scan mode
- Horizontal/Vertical 2/2-line binning mode
- Window cropping mode
- Vertical / Horizontal direction-normal / inverted readout mode
- Readout rate

Maximum frame rate in All-pixel scan mode 2592 (H) × 1944 (V) A/D 10-bit : 60 frame/s

- High dynamic range (HDR) function
 - Multiple exposure HDR

Digital overlap HDR

- Variable-speed shutter function (resolution 1H units)
- ◆ 10-bit / 12-bit A/D converter
- ♦ CDS / PGA function
 - 0 dB to 30 dB : Analog Gain 30 dB (step pitch 0.3 dB)
 - 30.3 dB to 72 dB : Analog Gain 30 dB + Digital Gain 0.3 to 42 dB (step pitch 0.3 dB)
- Supports I/O CSI-2 serial data output (2 Lane / 4 Lane, RAW10 / RAW12 output)
- ◆ Recommended exit pupil distance: -30 mm to -∞

STARVIS

* STARVIS is a trademark of Sony Corporation. The STARVIS is back-illuminated pixel technology used in CMOS image sensors for surveillance camera applications. It features a sensitivity of 2000 mV or more per 1 μ m² (color product, when imaging with a 706 cd/m² light source, F5.6 in 1 s accumulation equivalent), and realizes high picture quality in the visible-light and near infrared light regions.

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Device Structure

- CMOS image sensor
- ♦ Image size
- Total number of pixels
- Number of effective pixels
- Number of active pixels
- Number of recommended recording pixels
- Unit cell size
- Optical black
- ♦ Dummy
- ♦ Package

Type 1/2.8 2704 (H) × 2104 (V) approx. 5.69 M pixels 2616 (H) × 1964 (V) approx. 5.14 M pixels 2616 (H) × 1960 (V) approx. 5.11 M pixels 2592 (H) × 1944 (V) approx. 5.04 M pixels 2.0 μ m (H) × 2.0 μ m (V) Horizontal (H) direction: Front 0 pixel, rear 0 pixel Vertical (V) direction: Front 13 pixels, rear 0 pixel Horizontal (H) direction: Front 0 pixel, rear 0 pixel Vertical (V) direction: Front 0 pixel, rear 0 pixel Vertical (V) direction: Front 0 pixel, rear 0 pixel 88 pin CSP BGA

Image Sensor Characteristics

(Tj = 60 °C)

Item		Value	Remarks
Sensitivity (F5.6)	Тур.	2200 Digit	1/30 s accumulation 12 bit converted value
Saturation signal	Min.	3895 Digit	12 bit converted value

Basic Drive Mode

Drive mode	Recommended number of recording pixels	Maximum frame rate [frame/s]	Output interface	ADC [bit]
All pixel	2592 (H) × 1944 (V) approx. 5.04 M pixels	60	CSI-2	10
Horizontal/ Vertical 2/2-line binning	1296 (H) × 972 (V) approx. 1.26 M pixels	60	CSI-2	10

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Cameras Applications

Y



Automotive Driver Pilot





Video Conference



Live Streaming

Eye Tracker Biometric Detection

Machine Vision

Agricultural Monitor



Night Vision Security

Drone and Sports Eagle Eyes



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Camera Module Pinout Definition Reference Chart

OmniVision Sony Samsung On-Semi Aptina Himax GalaxyCore PixArt SmartSens Sensors			
Pin Signal	Description		
DGND GND	ground for digital circuit		
AGND	ground for analog circuit		
PCLK DCK	DVP PCLK output		
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor		
MCLK XVCLK XCLK INCK	system input clock		
RESET RST	reset active low with internal pull-up resistor		
NC NULL	no connect		
SDA SIO_D SIOD	SCCB data		
SCL SIO_C SIOC	SCCB input clock		
VSYNC XVS FSYNC	DVP VSYNC output		
HREF XHS	DVP HREF output		
DOVDD	power for I/O circuit		
AFVDD	power for VCM circuit		
AVDD	power for analog circuit		
DVDD	power for digital circuit		
STROBE FSTROBE	strobe output		
FSIN	synchronize the VSYNC signal from the other sensor		
SID	SCCB last bit ID input		
ILPWM	mechanical shutter output indicator		
FREX	frame exposure / mechanical shutter		
GPIO	general purpose inputs		
SLASEL	I2C slave address select		
AFEN	CEN chip enable active high on VCM driver IC		
MIPI Interface			
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output		
MDP0 DP0 MD0P DATA P DMO1P	MIPI 1st data lane positive output		
MDN1 DN1 MD1N DATA2_N DMO2N	MIPI 2nd data lane negative output		
MDP1 DP1 MD1P DATA2 P DMO2P	MIPI 2nd data lane positive output		
MDN2 DN2 MD2N DATA3 N DMO3N	MIPI 3rd data lane negative output		
MDP2 DP2 MD2P DATA3 P DMO3P	MIPI 3rd data lane positive output		
MDN3 DN3 MD3N DATA4 N DMO4N	MIPI 4th data lane negative output		
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output		
MCN CLKN CLK_N DCKN	MIPI clock negative output		
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output		
DVP Parallel Interface			
D0 D00 Y0	DVP data output port 0		
D1 D01 Y1	DVP data output port 1		
D2 D02 Y2	DVP data output port 2		
D3 D03 Y3	DVP data output port 3		
D4 D04 Y4	DVP data output port 4		
D5 D05 Y5	DVP data output port 5		
D6 D06 Y6	DVP data output port 6		
D7 D07 Y7	DVP data output port 7		
D8 D08 Y8	DVP data output port 8		
D9 D09 Y9	DVP data output port 9		
D10 D010 Y10	DVP data output port 10		
D11 D011 Y11	DVP data output port 11		

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Camera Reliability Test

Reliability Inspection Item			Testing Mathed	Accentance Criteria	
Category		Item	Testing Method	Acceptance Criteria	
	Storage	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Temperature	Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Operation	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation	
Environmental	Temperature	Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation	
Environmentai	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation	
	High 60°C 0.5 HoursThermal ShockLow -20°C 0.5 HoursCycling in 24 Hours		Temperature Chamber	No Abnormal Situation	
	Drop Test	Without Package 60cm	10 Times on Wood Floor	Electrically Functional	
	(Free Falling)	With Package 60cm	10 Times on Wood Floor	Electrically Functional	
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional	
Physical		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional	
Filysical		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional	
	Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional	
		Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional	
	ESD Test	Air Discharge 4 KV	ESD Testing Machine	Electrically Functional	
Electrical	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional	
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional	



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Camera Inspection Standard

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Inspection Item		Inspection Method	Standard of Inspection	
Categ	gory	Item	пересноп менной	Standard of Inspection
		Color	The Naked Eye	Major Difference is Not Allowed.
	FPC/ PCB	Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)
		Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed
	Holder	Gap	The Naked Eye	Meet the Height Standard
Appearance	HOIDEI	Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed
		Scratch	The Naked Eye	No Effect On Resolution Standard
	Long	Contamination	The Naked Eye	No Effect On Resolution Standard
	Lens	Oil Film	The Naked Eye	No Effect On Resolution Standard
		Cover Tape	The Naked Eye	No Issue On Appearance.
		No Communication	Test Board	Not Allowed
	Image	Bright Pixel	Black Board	Not Allowed In the Image Center
		Dark Pixel	White board	Not Allowed In the Image Center
		Blurry	The Naked Eye	Not Allowed
		No Image	The Naked Eye	Not Allowed
		Vertical Line	The Naked Eye	Not Allowed
		Horizontal Line	The Naked Eye	Not Allowed
Function		Light Leakage	The Naked Eye	Not Allowed
		Blinking Image	The Naked Eye	Not Allowed
		Bruise	Inspection Jig	Not Allowed
		Resolution	Chart	Follows Outgoing Inspection Chart Standard
		Color	The Naked Eye	No Issue
		Noise	The Naked Eye	Not Allowed
		Corner Dark	The Naked Eye	Less Than 100px By 100px
	-	Color Resolution	The Naked Eye	No Issue
		Height	The Naked Eye	Follows Approval Data Sheet
Dimen	sion	Width	The Naked Eye	Follows Approval Data Sheet
Dimen	131011	Length	The Naked Eye	Follows Approval Data Sheet
		Overall	The Naked Eye	Follows Approval Data Sheet

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YDSCAM Package Solutions

YDS Camera Module



Tray with Grid and Space

Complete with Lens Protection Film



Place Cameras on the Tray





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YDSCAM Package Solutions

Full Tray of Cameras

DS



Place Tray into Anti-Static Bag

Cover Tray with Lid



Vacuum the Anti-Static Bag



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YDSCAM Package Solutions

Sealed Vacuum Anti-Static Bag with Labels

1. Model and Description 2. Quantity 3. Manufacturing Date Code 4. Caution



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YDSCAM Package Solutions

Place Foam Sheets Between Tray Bags



Place Foam Sheets and Trays into Box



Seal the Carbon Box



Foam Sheets are Larger Than Trays



Foam Sheets are Tightly Fitting in Box



Label the Carbon Shipping Box



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YDSCAM Package Solutions

USB Camera Module







Place Camera Sample into Anti-Static Bag

Place USB Cameras into Tray







Seal the Tray with Anti-Static Bag



Label the Carbon Shipping Box



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Complete with Lens Protection Film



YDSCAM Package Solutions

Place Camera Sample into Anti-Static Bag





Label the Sample Bags

Place Connectors into Anti-Static Bag



Place Connectors into Reel



Place Samples into the Carbon Box





Place Connectors into the Carbon Box



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YDS

Company YDSCAM

YingDeShun Co. Ltd. (YDS) was established in 2017, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. YDS is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

YDS provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. YDS specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



Limited Warranty

YDS provides the following limited warranty if you purchased the Product(s) directly from YDS company or from YDS's website <u>www.YDSCAM.com</u>. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. YDS guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, YDS will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of YDS is solely limited to repair and/or replacement on the terms set forth above. YDS is not reliable or responsible for any subsequential events.



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YDS Strength

Y

Powerful Factory



Professional Service



Promised Delivery



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